

This datasheet of **Akulon® Care K1G6** from **Envalior** is provided by the international plastics database **CAMPUS**.

Akulon® Care K1G6 | PA6-GF30 | Envalior

Product Texts

30% Glass Reinforced, Medical grade, Food Contact Quality

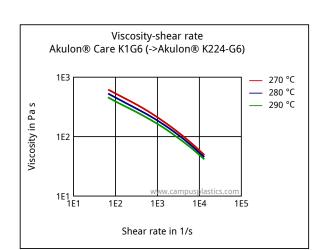
ISO 1043 PA6-GF30

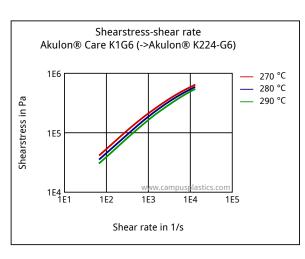
Rheological properties	dry / cond	Unit
Melt volume-flow rate, MVR	6.4 / *	cm³/10min
Temperature	240 / *	°C
Load	2.16 / *	kg
Molding shrinkage, parallel	0.3 / *	%
Molding shrinkage, normal	0.9 / *	%
Mechanical properties	dry / cond	Unit
Tensile modulus	9500 / 6000	MPa
Stress at break	180 / 110	MPa
Strain at break	3.5 / 7	%
Charpy impact strength, +23°C	90 / 110	kJ/m²
Charpy impact strength, -30°C	75 / 75	kJ/m²
Charpy notched impact strength, +23°C	12 / 25	kJ/m²
Charpy notched impact strength, -30°C	11 / 11	kJ/m²
Shore D hardness	- / 85	-
Thermal properties	dry / cond	Unit
Melting temperature, 10°C/min	220 / *	°C
Temp. of deflection under load, 1.80 MPa	200 / *	°C
Temp. of deflection under load, 0.45 MPa	220 / *	°C
Coeff. of linear therm. expansion, parallel	20 / *	E-6/K
Coeff. of linear therm. expansion, normal	70 / *	E-6/K
Burning behavior at 1.5 mm nominal thickness This website uses cookies. By using this website, you ag	HB / * ree to the yse o	class f cookies. P

Yellow Card available	Yes / *	-
Burning behavior at thickness h	HB/*	class
Thickness tested (h)	3.0 / *	mm
Yellow Card available	Yes / *	-
Electrical properties	dry / cond	Unit
Relative permittivity, 100Hz	3.5 / 20	-
Relative permittivity, 1MHz	3.3 / 5	-
Dissipation factor, 100Hz	50 / 3000	E-4
Dissipation factor, 1MHz	150 / 1200	E-4
Volume resistivity	1E13 / 1E11	Ohm*m
Surface resistivity	* / 1E14	Ohm
Electric strength	30 / 25	kV/mm
Comparative tracking index	* / 600	-
Other properties	dry / cond	Unit
Water absorption	6.3 / *	%
Humidity absorption	1.9 / *	%
Density	1350 / -	kg/m³
Rheological calculation properties	Value	Unit
Density of melt	1150	kg/m³
Thermal conductivity of melt	0.27	W/(m K)
Spec. heat capacity melt	2110	J/(kg K)

Diagrams

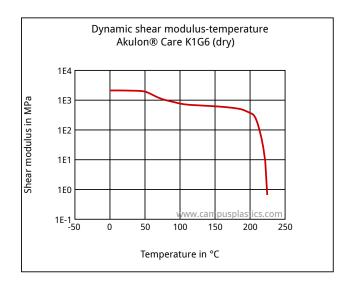
Eff. thermal diffusivity

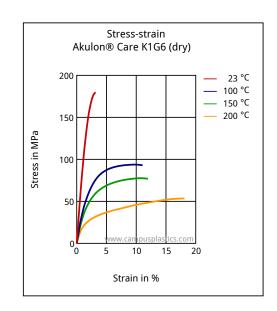


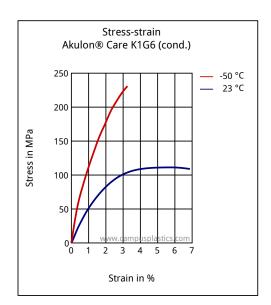


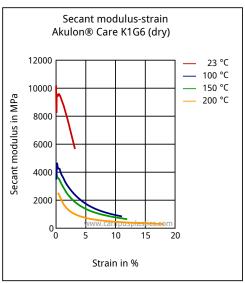
1.12E-7

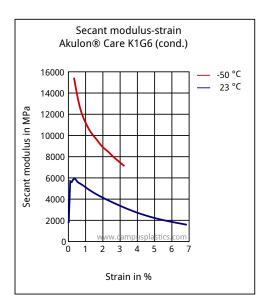
m²/s

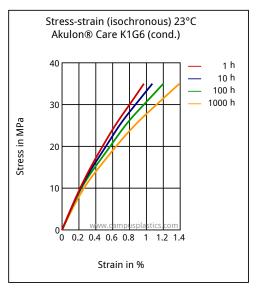


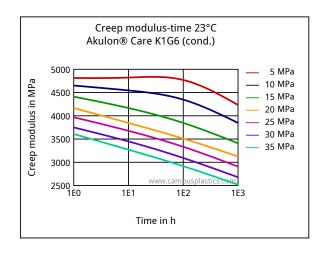


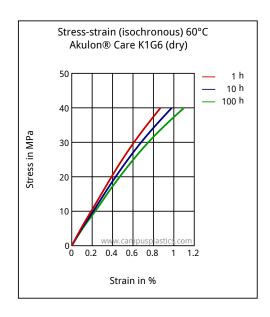


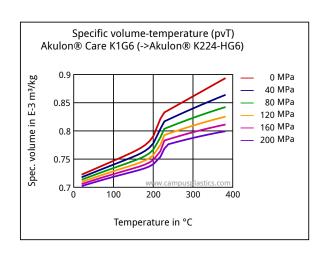












Characteristics

Processing

Injection Molding

Delivery form

Pellets

Regional Availability

North America, Europe, Asia Pacific

Other text information

Injection molding

Injection Molding Recommendations
Steel recommendations for molds screws and barrels
Trouble shooting guideline for injection molding

Chemical Media Resistance

Alcohols

Methanol (23°C)

Hydrocarbons	i
	Toluene (23°C)
Ketones	
	Acetone (23°C)
Ethers	
	Diethyl ether (23°C)
Other	

Ethyl Acetate (23°C)

Water (23°C)

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